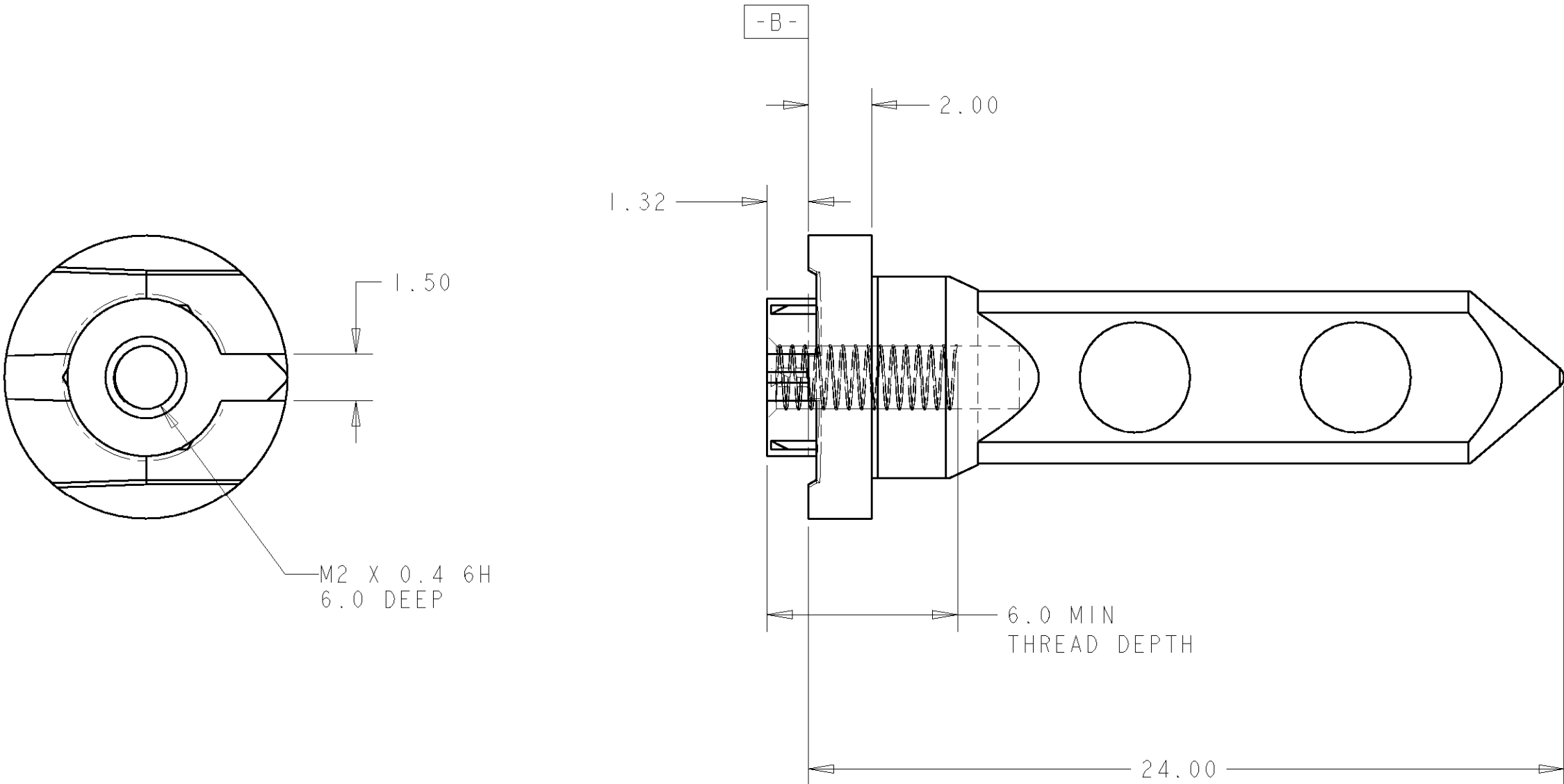
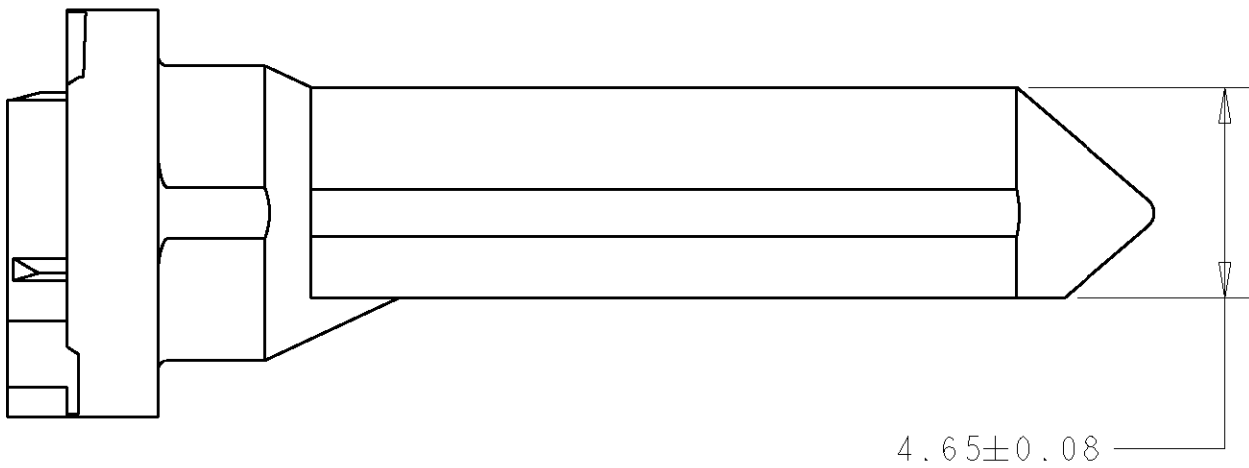
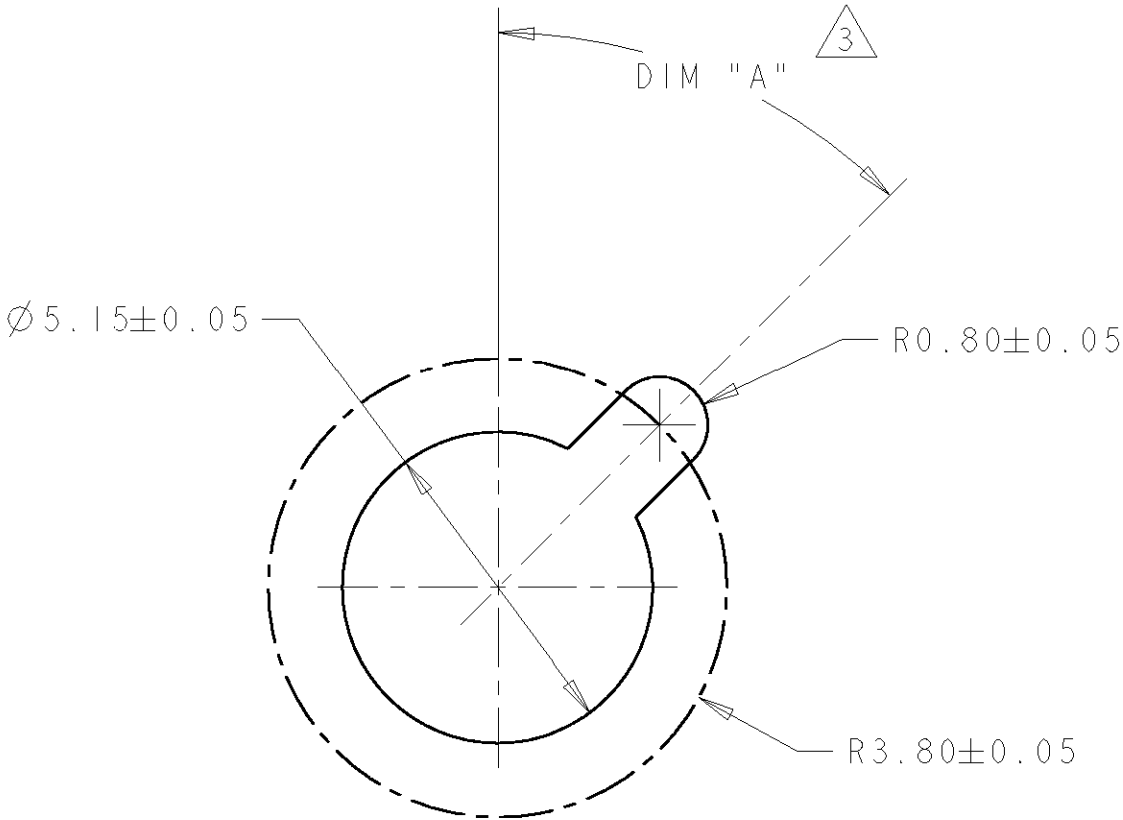
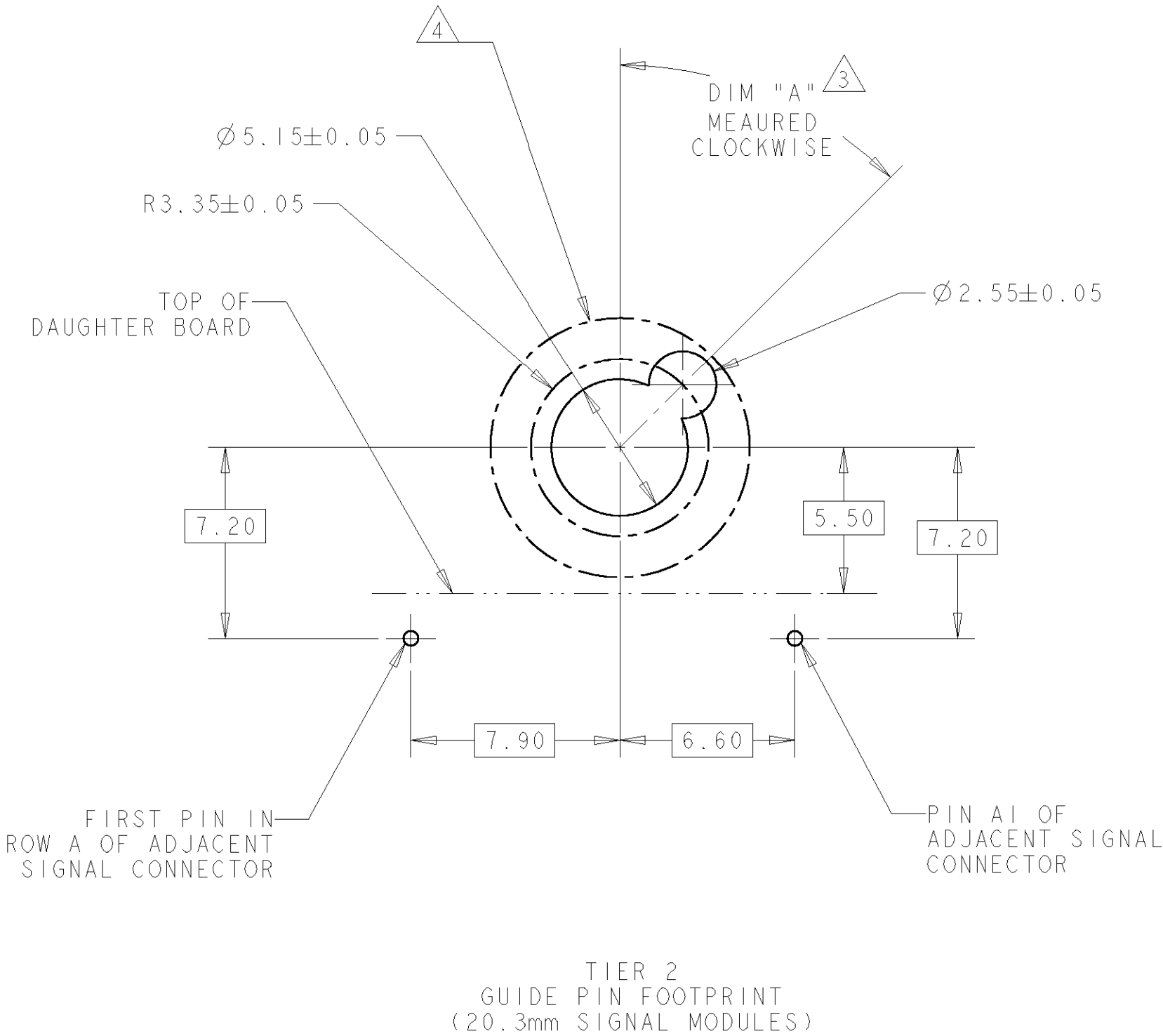


LOC	DIST	REVISIONS					
		P	LTR	DESCRIPTION	DATE	DWN	APVD
AD	00		A	RELEASED	22MAR2007	BC	GG

- 1 MATERIAL: ZINC ALLOY
- 2 FINISH:
3.81µm MINIMUM SILVER IN CONTACT AREA
OVER NICKEL OVER COPPER ALL OVER
- 3 KEY HOLE ORIENTATION (DIM A) PER MATING
GUIDE MODULE PART NUMBER TABLE
(ORIENTATION SHOWN ON PCB LAYOUT IS FOR 1-1469492-2)
- 4 ANNULAR RING PLATED AROUND GUIDE PIN MOUNTING
HOLE ON TOP AND BOTTOM SIDE OF BOARD



LOC	DIST	REVISIONS				
AD	00	P	LTR	DESCRIPTION	DATE	APVD
		-		SEE SHEET 1	-	-



-	I-1469492-9
315°	I-1469492-8
270°	I-1469492-7
90°	I-1469492-3
45°	I-1469492-2
0°	I-1469492-1
DIM " A "	20.3mm GUIDE MODULE
MATING GUIDE MODULE	

THIS DRAWING IS A CONTROLLED DOCUMENT FOR TYCO ELECTRONICS CORPORATION. IT IS SUBJECT TO CHANGE AND THE CONTROLLING ENGINEERING ORGANIZATION SHOULD BE CONTACTED FOR THE LATEST REVISION.		DWN R. TREA 22MAR2007	Tyco Electronics Harrisburg, PA 17105-3608	
		CHK G. GRIFFITH 22MAR2007		
		APVD G. GRIFFITH 22MAR2007	NAME KEYED GUIDE PIN, DIE CAST BACKPLANE CONNECTOR MULTIGIG, INTERNALLY THREADED	
DIMENSIONS: mm		PRODUCT SPEC -		
		APPLICATION SPEC -	SIZE A200779	
		WEIGHT -	DRAWING NO C-1410955	
MATERIAL -		CUSTOMER DRAWING	RESTRICTED TO -	
		SCALE 8:1		SHEET 2 OF 2
				REV A